

30V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	Max R _{DS(on)}	Max I _D @ T _A = 25°C
	1Ω @ V _{GS} = -4.5V	-0.76A
-30V	1.5Ω @ V _{GS} = -2.5V	-0.62A
	2Ω @ V _{GS} = -1.8V	-0.54A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

· Load Switch in portable electronics

Features and Benefits

- Footprint of just 0.6mm² thirteen times smaller than SOT23
- 0.4mm profile ideal for low profile applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected Gate 2KV
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

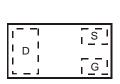
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (approximate)



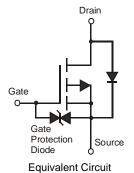




Bottom View



Top View Internal Schematic



Ordering Information (Note 3)

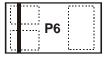
ſ	Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
	DMP31D0UFB4-7B	P6	7	8	10,000

Notes:

- 1. No purposefully added lead
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

DMP31D0UFB4-7B



Top View Bar Denotes Gate And Source Side

P6 = Product Type Marking Code



Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current	ontinuous Drain Current Steady State $T_A = 25^{\circ}\text{C (Note 5)}$ $T_A = 85^{\circ}\text{C (Note 5)}$ $T_A = 25^{\circ}\text{C (Note 4)}$		I _D	-0.76 -0.55 -0.54	А
Pulsed Drain Current (Note 5)			I _{DM}	2	А

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Dawer Dissipation	(Note 4)	Б	0.46	W	
Power Dissipation	(Note 5)	P _D	0.92] vv	
Thermal Desistance, Junction to Ambient	(Note 4)		271	°C/W	
Thermal Resistance, Junction to Ambient	(Note 5)	$R_{\theta JA}$	136	T C/VV	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Notes:

- 4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate
- 6. Device mounted on minimum recommended pad layout test board, 10μs pulse duty cycle = 1%.

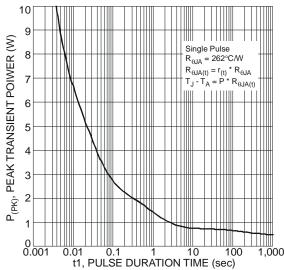
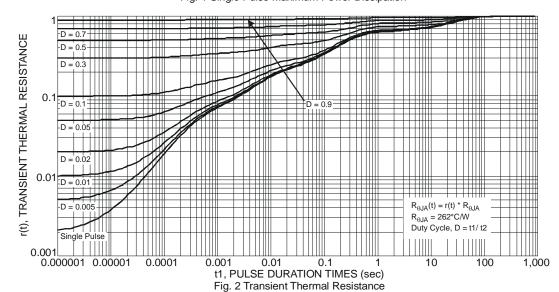


Fig. 1 Single Pulse Maximum Power Dissipation



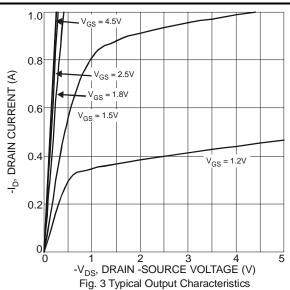


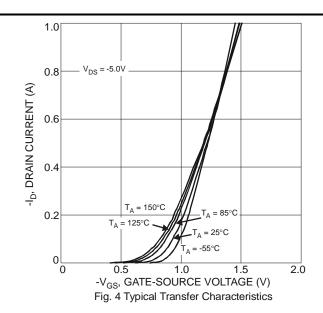
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±3	μΑ	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	-0.5	-	-1.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
				1		$V_{GS} = -4.5V$, $I_D = -400mA$	
Static Drain-Source On-Resistance	R _{DS (ON)}	-	-	1.5	Ω	$V_{GS} = -2.5V, I_D = -200mA$	
	, ,			2		V _{GS} = -1.8V, I _D = -100mA	
Forward Transfer Admittance	Y _{fs}	50	=	-	mS	$V_{DS} = -3V, I_{D} = -300 \text{mA}$	
Diode Forward Voltage	V_{SD}	-	-	-1.2	V	$V_{GS} = 0V, I_S = -300mA$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{iss}	·	76	ı	pF	V 45V V 6V	
Output Capacitance	Coss	-	9	-	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C_{rss}	-	6.43	-	pF	T = 1.0WITE	
Gate Resistance	R_g	-	166.9	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg		0.9	-	nC	$V_{GS} = -4.5V, V_{DS} = -15V, I_{D} = -1A$	
Total Gate Charge	Q_{g}	-	1.5	-	nC	V 0V V 45V	
Gate-Source Charge	Q _{gs}	-	0.1	-	nC	$V_{GS} = -8V, V_{DS} = -15V,$	
Gate-Drain Charge	Q_{gd}	-	0.2	-	nC	$I_D = -1A$	
Turn-On Delay Time	t _{D(on)}	-	4.98	-	ns		
Turn-On Rise Time	t _r	-	5.85	-	ns	$V_{DD} = -10V$, $R_L = 10 \Omega$	
Turn-Off Delay Time	t _{D(off)}	-	35.71	-	ns	V_{GS} = -4.5V, R_{G} = 6Ω	
Turn-Off Fall Time	t _f	-	16.64	-	ns	1	

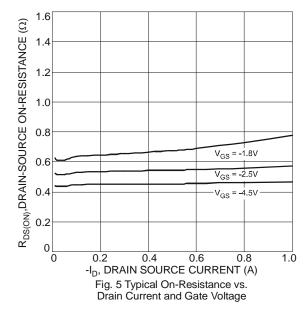
Notes: 7. Short duration pulse test used to minimize self-heating effect.

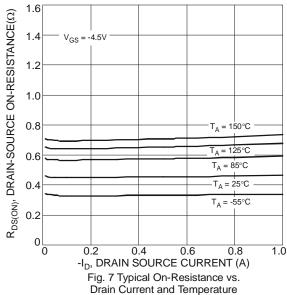
Typical Electrical Characteristics

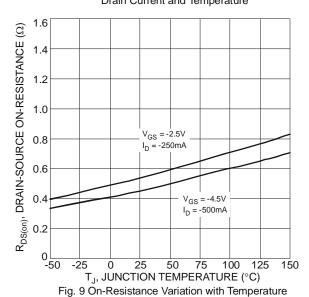


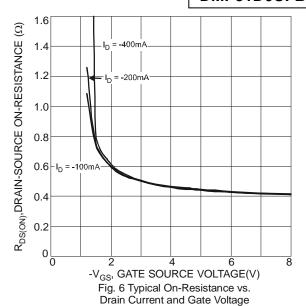


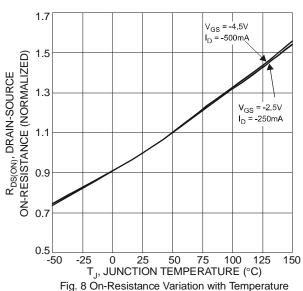












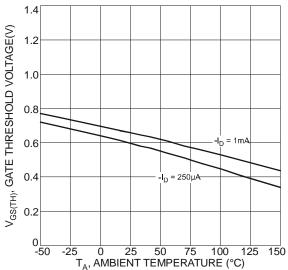
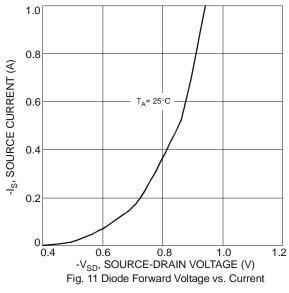


Fig. 10 Gate Threshold Variation vs. Ambient Temperature





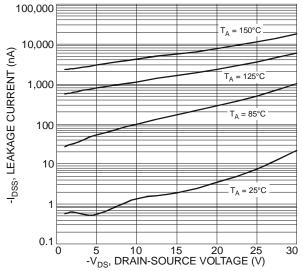
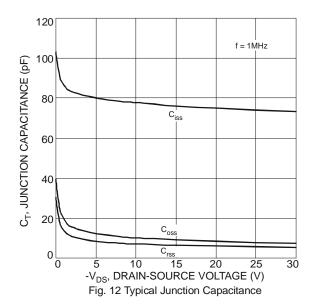
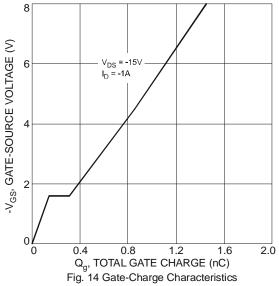


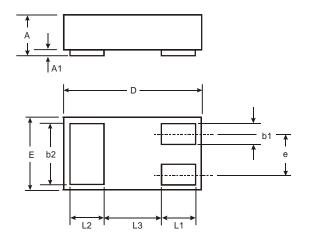
Fig. 13 Typical Drain-Source Leakage Current vs. Voltage





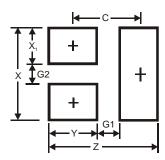


Package Outline Dimensions



X2-DFN1006-3					
Dim	Min	Max	Тур		
Α		0.40			
A1	0	0.05	0.02		
b1	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.075	1.00		
E	0.55	0.675	0.60		
е	_	_	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	_	_	0.40		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Υ	0.4
C	0.7





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7 of 7

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